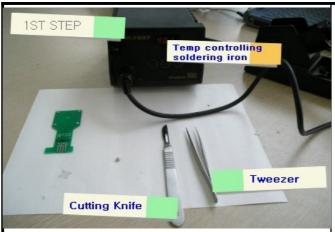
MOUNTING SAMPLE ON BOARD (1)

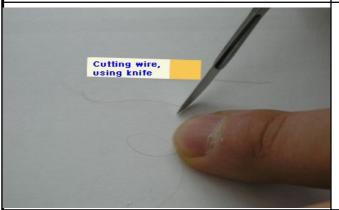


User has to prepare for left cutting knife, tweezer, temperature control soldering iron, Sample board and InSn compound.



When soldering, pls set up soldering iron on $350 \sim 400 \,^{\circ}\text{C}$. It is best temp to solder.

Too high and too low temperature is not so good to solder.



Cutting copper wire or gold wire with proper size to connect, using sharp knife.

MOUNTING SAMPLE ON BOARD (2)

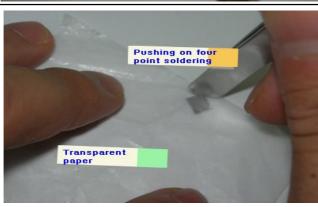


Cutting InSn compound minutely.

InSn can be usually used for electrical conductivity material. However, for some other samples, silver paste, carbon paste are recommended to improve ohmic contact.



Soldering in four points using soldering iron.
It has to be done in four points edge.
And, if it was not annealed sample, annealing about 1min might be helpful.

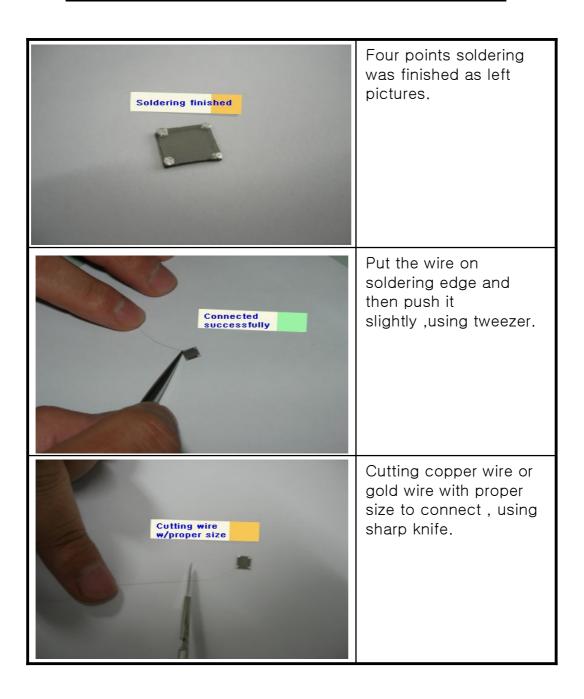


After soldering in four points edge, four points should be flat, using transparent paper and tweezer.

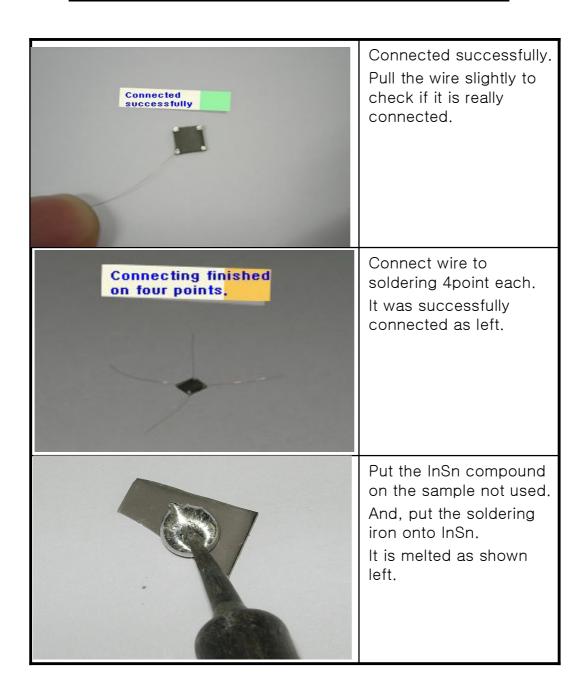
It might help to connect wire to soldering.

Just push slightly above, seeing through transparent paper.

MOUNTING SAMPLE ON BOARD (3)



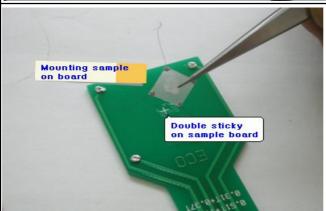
MOUNTING SAMPLE ON BOARD (4)



MOUNTING SAMPLE ON BOARD (5)



Put the soldering iron that has melted InSn compound onto four point as shown left. It 's o.k to be proceeded in the first step in advance.



Put the connected sample on the center of the PCB board.

There is double sticky tape on the center of the sample.

And, then connect wire on the soldering of 4point of PCB.



It was finished to connect wire to soldering on 4points and mounting sample on PCB board.